

XP152A11E5MR-G

ETR11020_004

Power MOSFET

■ GENERAL DESCRIPTION

The XP152A11E5MR-G is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

In order to counter static, a gate protect diode is built-in.

The small SOT-23 package makes high density mounting possible.

■ APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■ FEATURES

Low On-State Resistance : $R_{ds(on)} = 0.25 \Omega$ @ $V_{gs} = -10V$
 : $R_{ds(on)} = 0.45 \Omega$ @ $V_{gs} = -4.5V$

Ultra High-Speed Switching

Gate Protect Diode Built-in

Driving Voltage : -4.5V

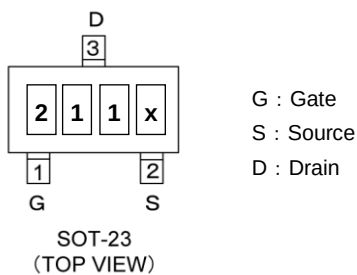
P-Channel Power MOSFET

DMOS Structure

Small Package : SOT-23

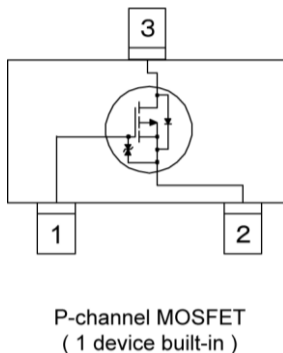
Environmentally Friendly : EU RoHS Compliant, Pb Free

■ PIN CONFIGURATION/ MARKING



* x represents production lot number.

■ EQUIVALENT CIRCUIT



■ PRODUCT NAMES

PRODUCTS	PACKAGE	ORDER UNIT
XP152A11E5MR	SOT-23	3,000/Reel
XP152A11E5MR-G(*)	SOT-23	3,000/Reel

(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ ABSOLUTE MAXIMUM RATINGS

$T_a = 25^\circ\text{C}$

PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	V_{dss}	-30	V
Gate - Source Voltage	V_{gss}	± 20	V
Drain Current (DC)	I_d	-0.7	A
Drain Current (Pulse)	I_{dp}	-2.8	A
Reverse Drain Current	I_{dr}	-0.7	A
Channel Power Dissipation *	P_d	0.5	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55~150	$^\circ\text{C}$

* When implemented on a ceramic PCB

ELECTRICAL CHARACTERISTICS

DC Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	Idss	Vds= -30V, Vgs= 0V	-	-	-10	μA
Gate-Source Leak Current	Igss	Vgs= ±20V, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= -1mA, Vds= -10V	-1.0	-	-3.0	V
Drain-Source On-State Resistance *1	Rds(on)	Id= -0.4A, Vgs= -10V	-	0.20	0.25	Ω
		Id= -0.4A, Vgs= -4.5V	-	0.35	0.45	Ω
Forward Transfer Admittance *1	Yfs	Id= -0.4A, Vds= -10V	-	1	-	S
Body Drain Diode Forward Voltage	Vf	If= -0.7A, Vgs= 0V	-	-0.8	-1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= -10V, Vgs=0V f= 1MHz	-	160	-	pF
Output Capacitance	Coss		-	120	-	pF
Feedback Capacitance	Crss		-	50	-	pF

Switching Characteristics

Ta = 25°C

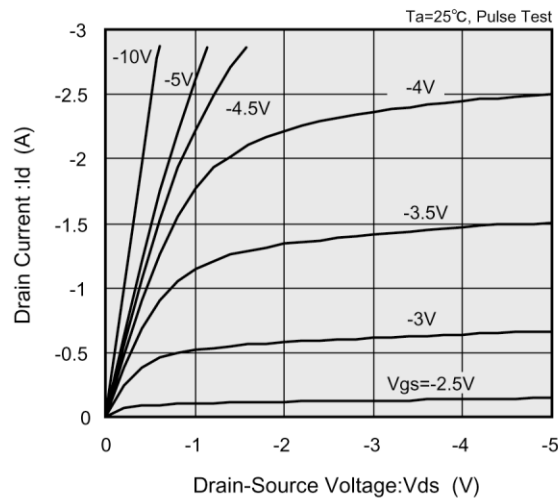
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= -5V, Id= -0.4A Vdd= -10V	-	10	-	ns
Rise Time	tr		-	25	-	ns
Turn-Off Delay Time	td (off)		-	25	-	ns
Fall Time	tf		-	40	-	ns

Thermal Characteristics

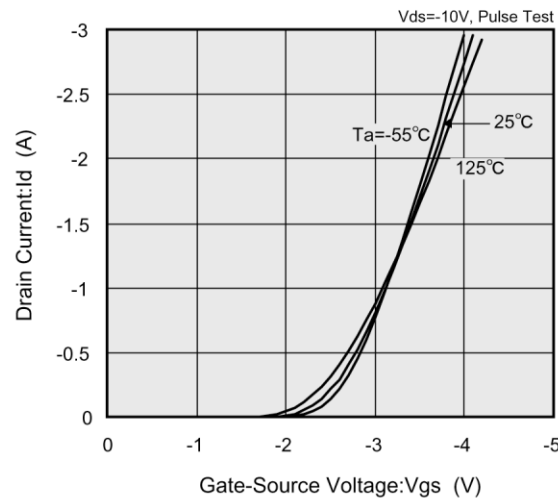
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	250	-	°C/W

TYPICAL PERFORMANCE CHARACTERISTICS

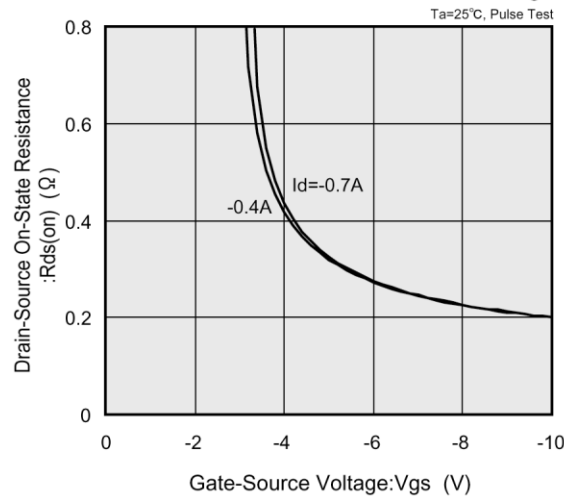
(1) Drain Current vs. Drain-Source Voltage



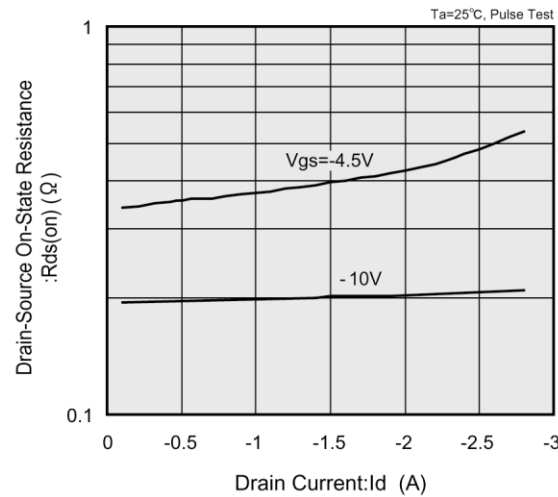
(2) Drain Current vs. Drain-Source Voltage



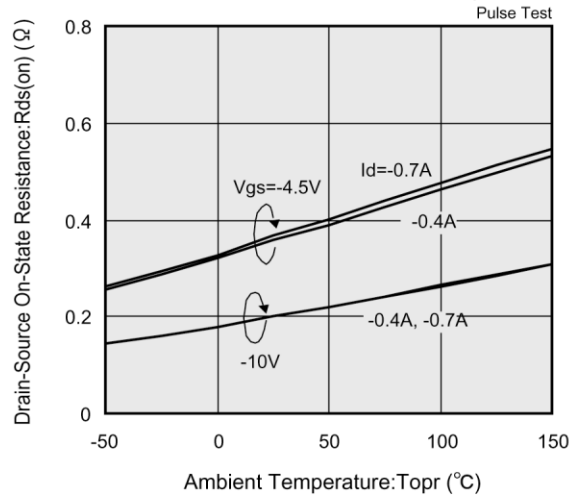
(3) Drain-Source On-State Resistance vs. Gate-Source Voltage



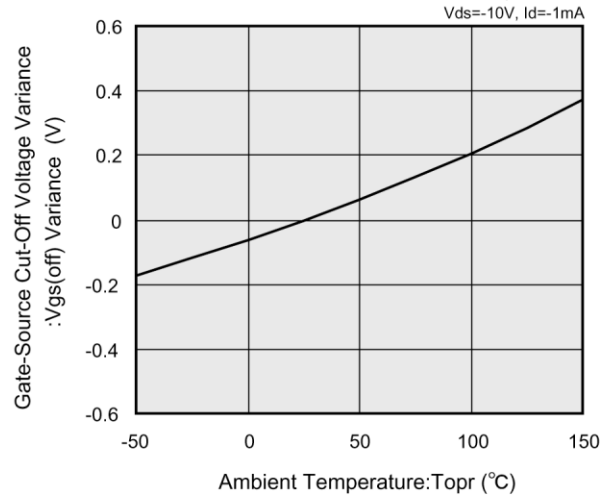
(4) Drain-Source On-State Resistance vs. Drain Current



(5) Drain-Source On-State Resistance vs. Ambient Temperature

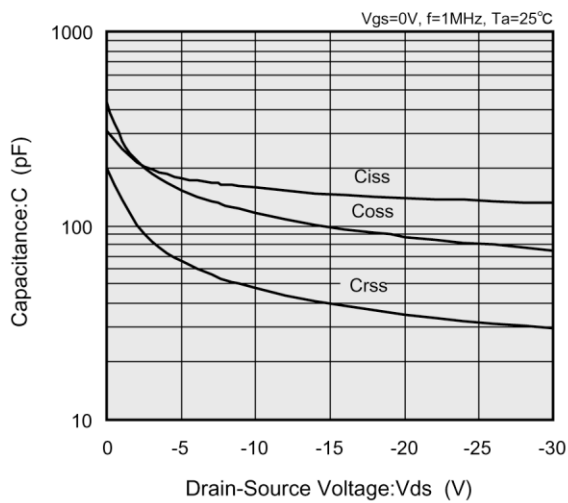


(6) Gate Source Cut-Off Voltage Variance vs. Ambient Temperature

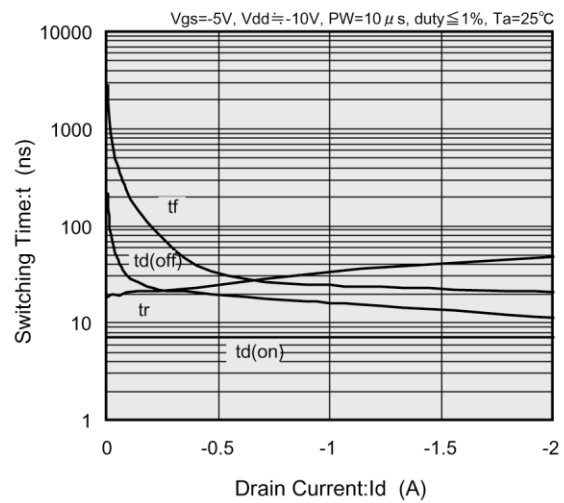


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

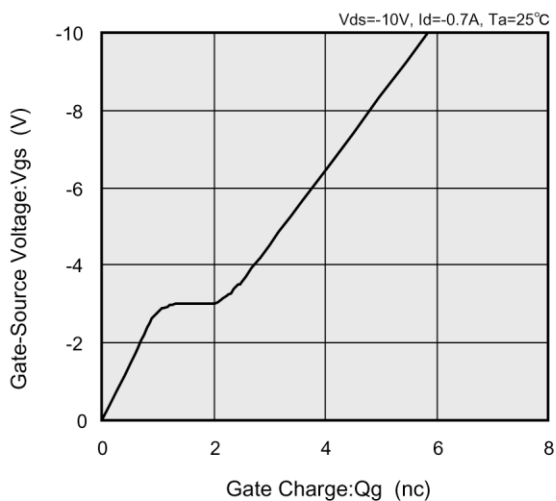
(7) Capacitance vs. Drain-Source Voltage



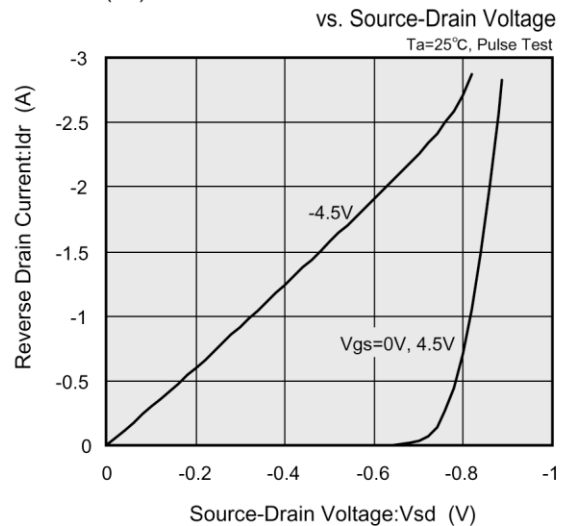
(8) Switching Time vs. Drain Current



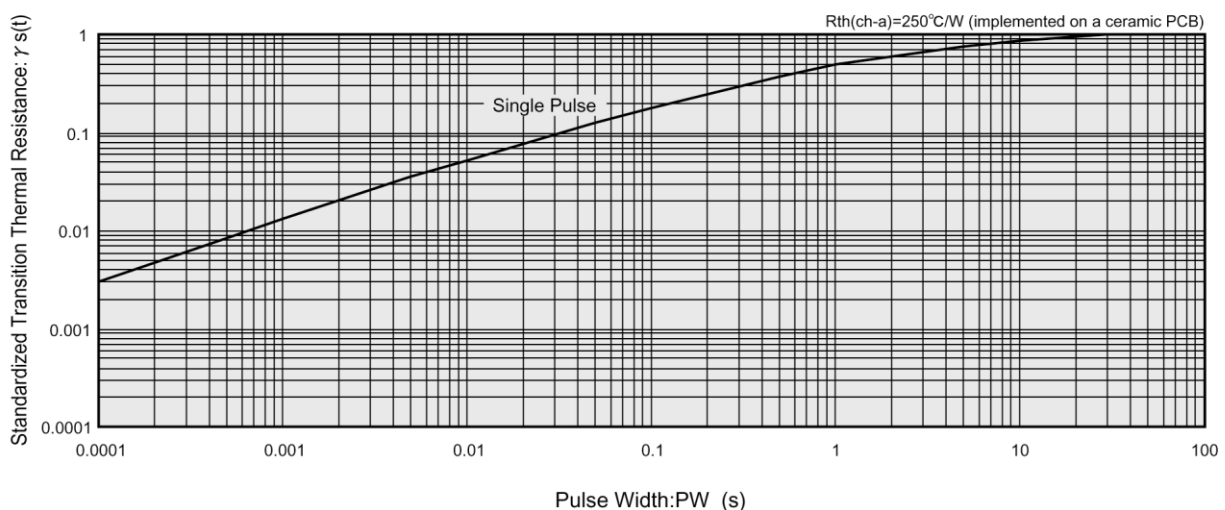
(9) Gate-Source Voltage vs. Gate Charge



(10) Reverse Drain Current



(11) Standardized transition Thermal Resistance vs. Pulse Width



■PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

PACKAGE	OUTLINE / LAND PATTERN	THERMAL CHARACTERISTICS
SOT-23	SOT-23 PKG	SOT-23 Power Dissipation

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